

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π -MOSV)

2SK2914

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS
 CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

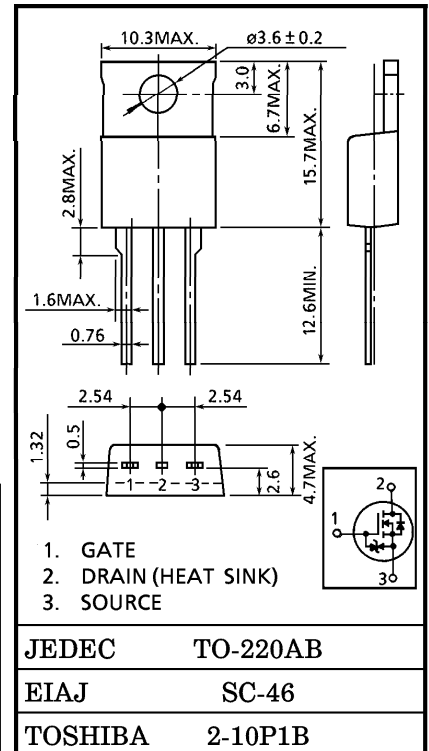
INDUSTRIAL APPLICATIONS

Unit in mm

- Low Drain-Source ON Resistance : $R_{DS(ON)} = 0.42\Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 7.5S$ (Typ.)
- Low Leakage Current : $I_{DSS} = 100\mu A$ (Max.)
($V_{DS} = 250V$)
- Enhancement-Mode : $V_{th} = 1.5 \sim 3.5V$
($V_{DS} = 10V, I_D = 1mA$)

MAXIMUM RATINGS ($T_a = 25^\circ C$)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	250	V
Drain-Gate Voltage ($R_{GS} = 20k\Omega$)		V_{DGR}	250	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	DC	I_D	7.5	A
	Pulse	I_{DP}	30	
Drain Power Dissipation ($T_c = 25^\circ C$)		P_D	20	W
Single Pulse Avalanche Energy**		E_{AS}	110	mJ
Avalanche Current		I_{AR}	7.5	A
Repetitive Avalanche Energy*		E_{AR}	2	mJ
Channel Temperature		T_{ch}	150	$^\circ C$
Storage Temperature Range		T_{stg}	$-55 \sim 150$	$^\circ C$



Weight : 2.0g (Typ.)

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	6.25	$^\circ C/W$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	83.3	$^\circ C/W$

Note ;

* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

** $V_{DD} = 50V, T_{ch} = 25^\circ C$ (initial), $L = 3.3mH, R_G = 25\Omega, I_{AR} = 7.5A$

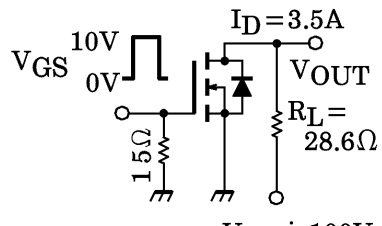
This transistor is an electrostatic sensitive device.

Please handle with caution.

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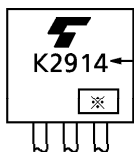
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		IGSS	VGS = ±16V, VDS = 0V	—	—	±10	μA
Drain Cut-Off Current		IDSS	VDS = 250V, VGS = 0V	—	—	100	μA
Drain-Source Breakdown Voltage		V(BR)DSS	ID = 10mA, VGS = 0V	250	—	—	V
Gate Threshold Voltage		Vth	VDS = 10V, ID = 1mA	1.5	—	3.5	V
Drain-Source ON Resistance		RDS(ON)	VGS = 10V, ID = 3.5A	—	0.42	0.5	Ω
Forward Transfer Admittance		Yfs	VDS = 10V, ID = 3.5A	4	7.5	—	S
Input Capacitance		Ciss	VDS = 10V, VGS = 0V, f = 1MHz	—	700	—	pF
Reverse Transfer Capacitance		Crss		—	80	—	
Output Capacitance		Coss		—	270	—	
Switching Time	Rise Time	tr	 <p>VIN : tr, tf < 5ns, Duty ≤ 1%, tw = 10μs</p>	—	10	—	ns
	Turn-On Time	ton		—	20	—	
	Fall Time	tf		—	10	—	
	Turn-Off Time	toff		—	70	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Qg	VDD ≈ 200V, VGS = 10V, ID = 7.5A	—	20	—	nC
Gate-Source Charge		Qgs		—	13	—	
Gate-Drain ("Miller") Charge		Qgd		—	7	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	IDR	—	—	—	7.5	A
Pulse Drain Reverse Current	IDRP	—	—	—	30	A
Diode Forward Voltage	VDSF	IDR = 7.5A, VGS = 0V	—	—	-2.0	V
Reverse Recovery Time	trr	IDR = 7.5A, VGS = 0V	—	180	—	ns
Reverse Recovery Charge	Qrr	dIDR / dt = 100A / μs	—	1.1	—	μC

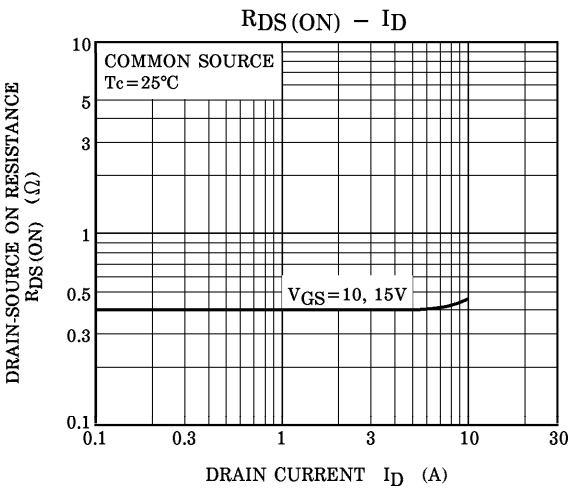
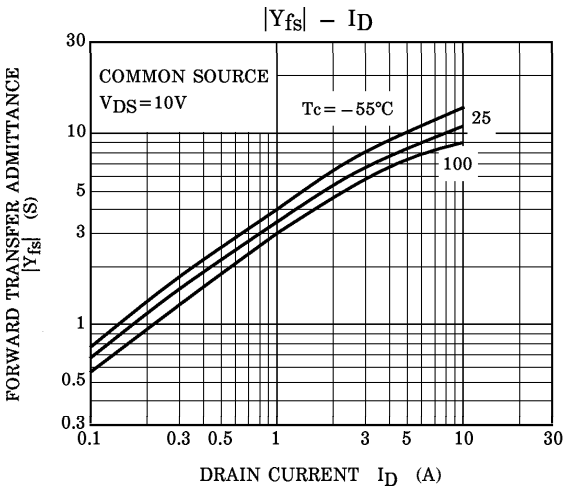
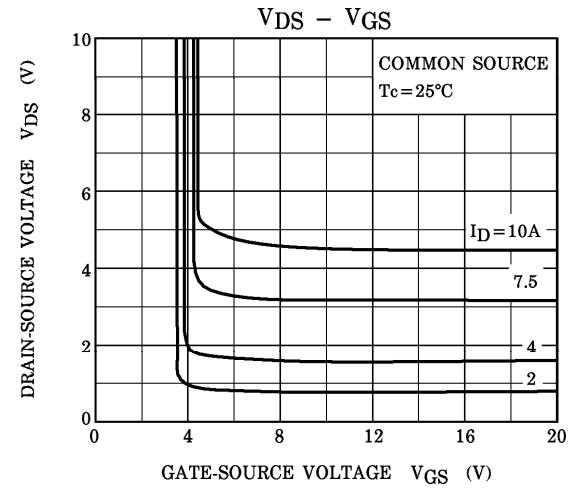
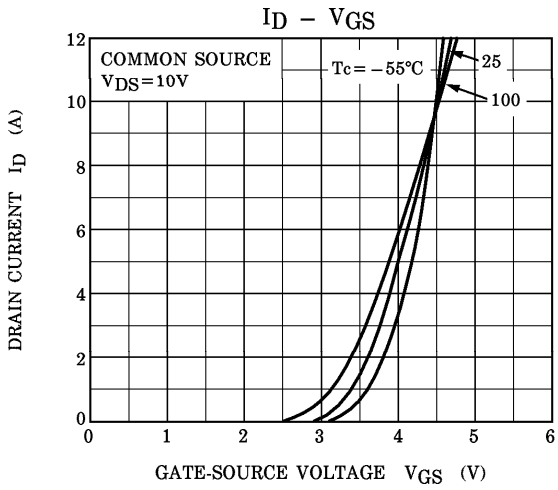
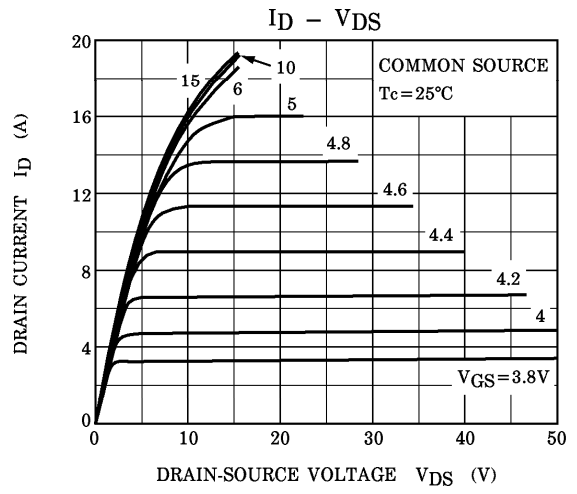
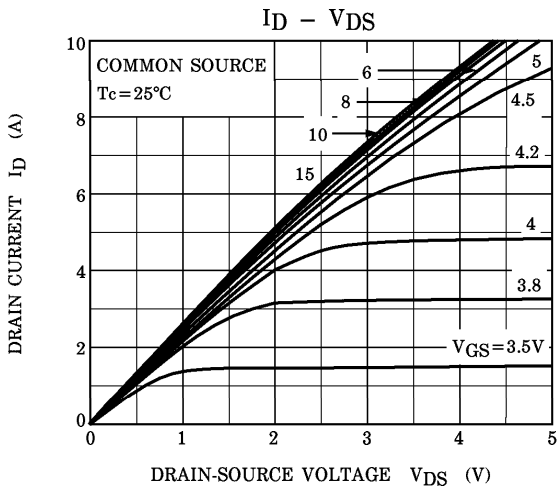
MARKING

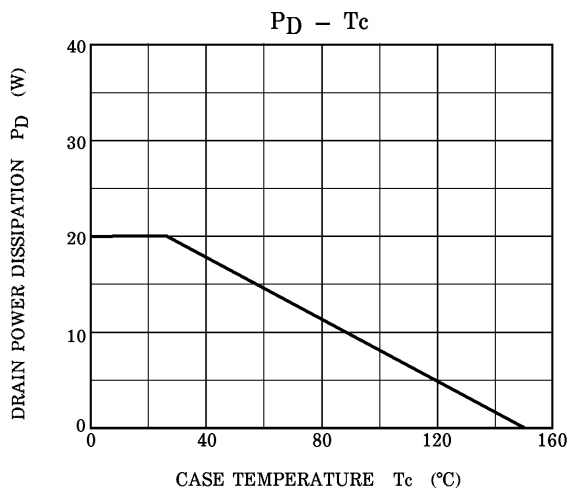
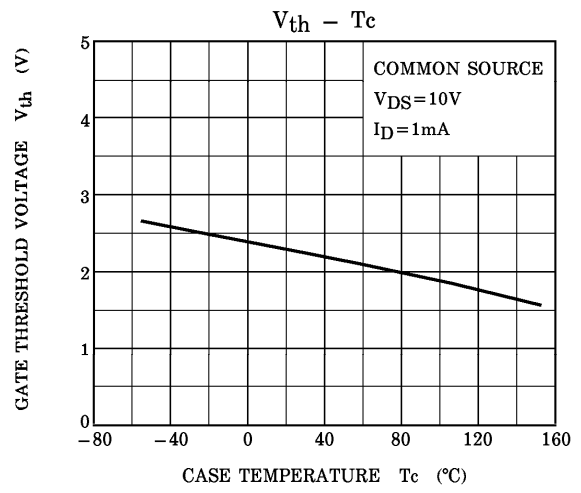
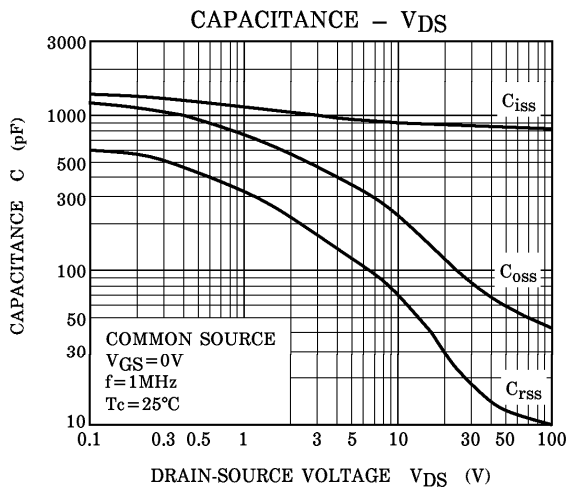
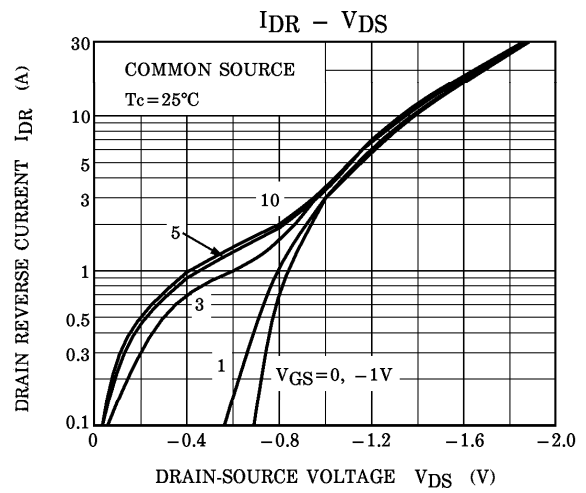
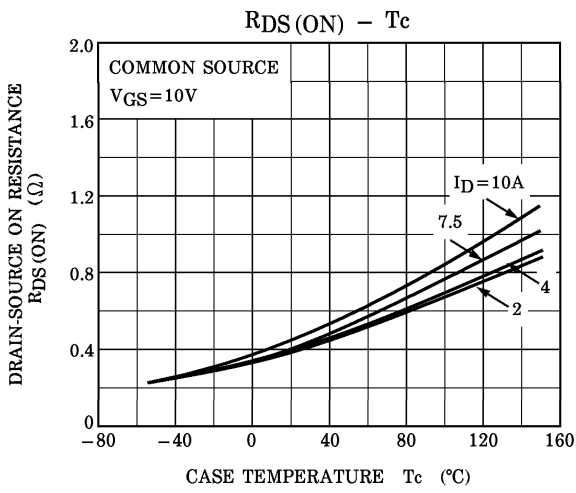


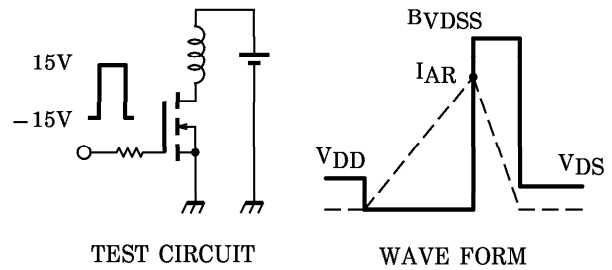
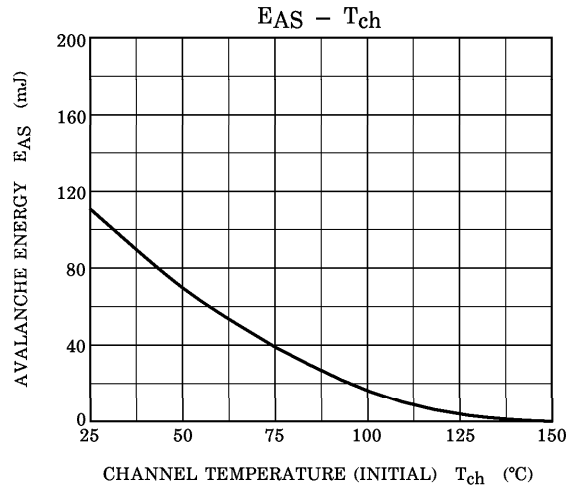
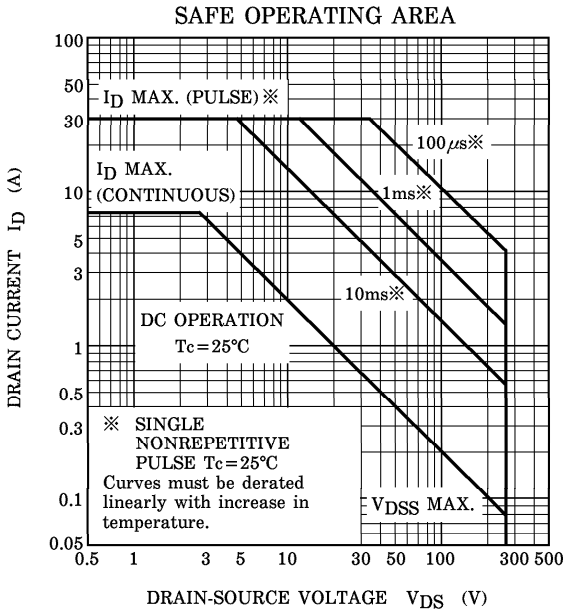
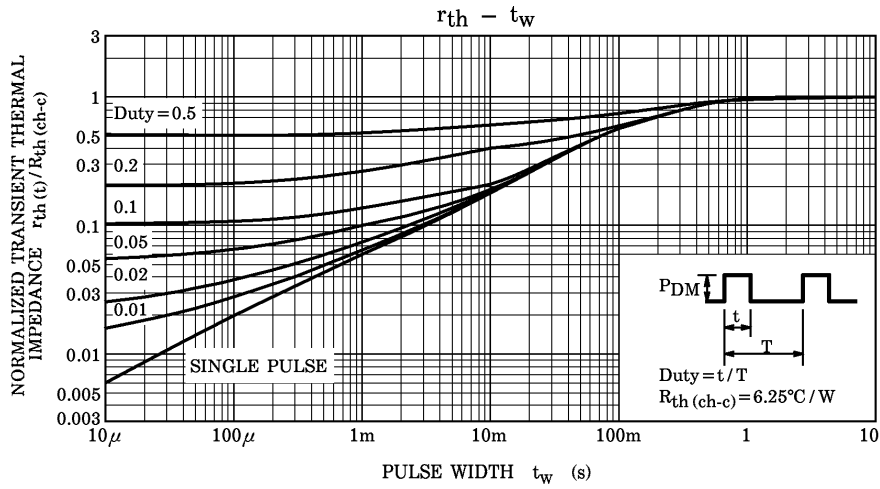
※ Lot Number

□ □ — Month (Starting from Alphabet A)

— Year (Last Number of the Christian Era)







Peak $I_{AR} = 7.5A$, $R_G = 25\Omega$, $V_{DD} = 50V$, $L = 3.3mH$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - V_{DD}} \right)$$